High Curie temperatures in ferromagnetic Cr-doped AlN thin films

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Al_{1-x}Cr_xN thin films with $0.02 \le x \le 0.1$ were deposited by reactive co-sputtering onto c-plane (001) sapphire. Room-temperature ferromagnetism with a coercive field of 85 Oe was observed in samples with chromium contents as low as x = 0.027 (2.7%). With increasing Cr content the mean magnetic moment is strongly suppressed, with a maximum saturation moment of 0.62 and 0.71 μ_B per Cr atom at 300 and 50 K respectively. We show that the Curie temperature of Al_{1-x}Cr_xN for x = 0.027 is greater than 900 K.

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Since the discovery of carrier-induced ferromagnetism in InMnAs and GaMnAs,^{1,2} there has been rapidly growing interest in the properties and potential applications of dilute magnetic semiconductors (DMS). The most significant limitation to application of these materials is the low Curie temperature (T_c) generally observed in DMS based on traditional compound semiconductors. This has prompted many groups to investigate alternatives including magnetically-doped oxides such as ZnO^{3,4} SnO₂ ⁵ and TiO₂ ⁶.

Theoretical predictions of room temperature ferromagnetism in 3d-transition-metaldoped GaN indicated that Mn and Cr-doped GaN are promising candidate DMS, with Crdoped GaN likely to exhibit the most stable ferromagnetic states⁷. Dietl *et al.* predicted from a mean field model that Mn-doped GaN should have a T_C higher than room temperature.⁸ Based on local-density functional calculations, the exchange interaction between magnetic dopants and III-V compounds may explain the maximum observed critical temperature at different impurity concentrations.⁹

Recently, room temperature ferromagnetism has been experimentally observed in Mn- and Cr- doped GaN and AlN.¹⁰⁻¹⁴ The T_C for (x = 0.03 - 0.05) Mn-doped GaN films has been reported to be over 750 K¹⁵ and ferromagnetic behavior with a T_C higher than 400 K has been reported for Cr-doped GaN.¹⁶ Previous studies on AlN have reported a large variation in the value of mean magnetic moment of Cr-doped AlN films depending on the technique of deposition and doping concentration,¹³⁻¹⁴ but it is clear that high Cr doping levels (x \geq 0.1) result in segregation. To date, samples with varying Cr

composition at levels (x < 0.05) have not been studied. In this letter, we report the growth of Al_{1-x}Cr_xN films and show that high T_C s can be obtained at low doping levels.

Thin film samples of Al_{1-x}Cr_xN, were deposited on c-plane (001) sapphire substrates by reactive D.C. co-sputtering from an Al and a Cr target in a UHV sputtering chamber surrounded by a liquid-nitrogen filled jacket with a base pressure below 3×10^{-7} Pa. A sputtering gas of 70% N₂ / 30% Ar at a total pressure of 3 Pa was used. The temperature of the platinum resistive heater, on which the substrates were placed, was held at 940 °C (using an optical pyrometer); the actual substrate temperature was approximately 150 °C below this.

The substrate heater was placed between the Al and Cr targets such that a series of $Al_{1-x}Cr_xN$ films with different Cr compositions could be fabricated on a set of 10×5 mm² substrates in one deposition run. In this geometry $Al_{1-x}Cr_xN$ films with Cr (x < 0.027) could not be deposited because of limitations on the relative powers which could be applied to the Al and Cr targets. The concentration of Cr in the films was estimated by energy dispersive X-ray analysis (EDX) of films deposited on to silica substrates placed at either end of the heater in each run; previous experiments had shown that our geometry gives an essentially linear composition spread and so the Cr-concentration of each sample could be accurately calculated from its position on the heater. Film structure and crystallographic texture were characterized using a Philips X-ray diffractometer (XRD) equipped with a Cu source. The magnetic measurements were carried out with the magnetic field parallel to the sample using a Princeton Measurement Corporation vibrating sample magnetometer fitted with a furnace and a cryostat which enabled measurements between 10 K and 800 K.

The thickness of films varied between 400 nm and 600 nm. Atomic Force Microscopy was used to characterize the surface morphology; the mean and root mean square roughness values for a typical film were 4.8 and 6.1 nm respectively. The surface topography suggested columnar growth.

Our growth conditions resulted in a preferred (002) orientation for pure AlN, i.e. caxis normal to the plane of the film. Fig. 1 shows $2\theta \cdot \theta$ XRD scans of Al_{1-x}Cr_xN thin films with different Cr levels deposited at the same temperature on c-plane sapphire. It can be seen that all the films are predominantly (002) oriented, but that with increasing *x* the intensities of other reflections increase relative to the (002) diffraction peak. For x = 0.027 and 0.035 only the (002) reflection at 36.1° can be observed; the sample with x = 0.046 the first indication of the (101) AlN peak appears; and for x = 0.061 this peak can clearly be observed. The same trend was observed in other deposition runs: preferred caxis orientation dropped with increasing Cr content. No peaks corresponding to any other possible phase, such as CrN, Cr₂N or CrO₂, were observed.

The magnetization versus magnetic field (*M-H*) loops for Al_{1-x}Cr_xN with x = 0.027and x = 0.061 at 300 K are shown in Fig. 2; both loops are strongly hysteretic, but it can be seen that the total moment for x = 0.061 is substantially lower than for x = 0.027. *M-H* loops measured for x = 0.027 at different temperatures (20 K- 800 K) were used to calculate the saturation magnetization moment (*M_S*), magnetic remanent magnetization (M_R) per Cr atom, are shown in Fig. 3¹⁷. Coercive field values as a function of temperature are also shown in this figure. It can be seen that the film is still strongly ferromagnetic at the highest measurement temperature of our system, 800 K. As expected, the data show a progressive reduction in M_S with increasing temperature but, as shown in Fig. 3, we have also consistently observed a reduction in M_S values with reducing temperature below than 50K. The effective magnetic moment per Cr atom, deduced from *M*-*H* loops measured at room temperature, as a function of x is plotted in Fig. 4. The data show a consistent reduction in total moment (inset of Fig. 4) with increasing Cr concentration.

The major difficulty in making AIN ferromagnetic is the low solubility limit¹⁸ for magnetic impurities such as Mn or Cr. However, there appears to be a narrow processing window in terms of deposition temperature and doping concentration at which effective ferromagnetic doping of AIN is possible and which also avoids second phase formation and maintains the preferred growth orientation.¹¹ Our films have been deposited under good vacuum conditions and so ferromagnetic CrO₂ formation, possible for the highly doped films of Yang *et al.*¹⁴ is extremely unlikely. XRD analysis does not detect any other phase, although this does not necessarily preclude the presence of nano-clusters of Cr or Cr-compounds.

The remanent magnetization for the 2.7% doped sample was found to decrease with increasing temperature (>50 K); however the films were strongly hysteretic at all temperatures. The coercive field and effective magnetization also decreased with increasing temperature. The relatively low signal to noise ratio at high temperatures prevented the use of Arrott plots to determine T_C ; however, the *M*-*H* measurements made at higher temperatures clearly indicate that T_C is higher than 800K. Extrapolation of the linear dependence of the remanent magnetization to higher temperatures implies a T_C well above 900 K, and probably closer to 1000 K.

The rapid decrease in effective saturation magnetic moment M_S per Cr atom with increasing Cr content may be associated with the decline in crystal quality with increasing Cr content or may be due to enhanced antiferromagnetic coupling at higher Cr concentrations. Alternatively, it is possible that this decrease is a consequence of an increasing chemical instability with higher Cr concentration which may lead to clustering. This decrease in total moment with increasing doping concentration is similar to that already reported for Mn-doped GaN films¹⁹. The reason for the decrease in M_S (< 50 K) is not understood, but may also indicate a competing antiferromagnetic coupling.

At present, there seems to be no single theoretical model which can explain the ferromagnetism in all DMS materials. Ferromagnetism based on free-carrier mediated models predicted for Mn-doped III-V semiconductors may not be applicable to AlN as it is highly resistive at room temperature. It has recently been proposed that small Cr-N clusters could be strongly ferromagnetic,²⁰ and so could account for the magnetic moment and high T_{C} s in Cr-doped III-V nitrides. However, this appears to be inconsistent with our data, in which ferromagnetism is strongest at the lowest Cr concentrations and, as noted by Hori *et al.*¹⁵, the small size of the clusters necessary for ferromagnetism seems certain to imply a superparamagnetic behaviour which is inconsistent with the hysteresis observed even at the highest temperatures in our films.

In conclusion, we have deposited ferromagnetic Cr-doped AlN films with strong (002) texture on c-plane sapphire, showing high saturation magnetization moments of 0.62 and $0.71\mu_B/Cr$ atom at 300 and 50 K respectively, for Cr contents as low as 2.7%. The magnetization measurements carried out at higher temperatures indicate that the Curie temperature of Cr-doped AlN is higher than 900 K. The most immediate

application for high temperature ferromagnetic AlN may be in spin electronic devices as a spin-filtering magnetic tunnel barrier.¹¹

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¹⁷ The magnetization moment values measured at high temperature (> 400 °C) using VSM in furnace mode required a different sample geometry and so these data have been scaled to the value obtained at room temperature.

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Figure captions

FIG. 1 X-ray diffraction patterns of $Al_{1-x}Cr_xN$ samples with varying Cr composition $(0.02 \le x \le 0.1)$, deposited on c-plane (001) sapphire at heater temperature of 940 °C.

FIG. 2 Magnetic field dependence of the magnetization of $Al_{1-x}Cr_xN$ films for x = 0.027and 0.061 at 300 K.

FIG. 3Temperature dependence of the effective saturation magnetic moment (M_S), magnetic remanent magnetization (M_R), and coercive field (H_c) of $Al_{1-x}Cr_xN$ with x = 0.027.

FIG. 4 Effective magnetic moment per Cr atom for $Al_{1-x}Cr_xN$ film as a function of Cr concentration measured at 300K; different growth runs are distinguished by different symbols. The inset shows the same data expressed as moment per unit volume.

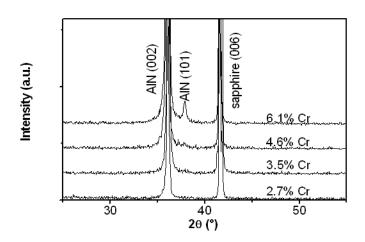


FIG. 1. – Kumar et al

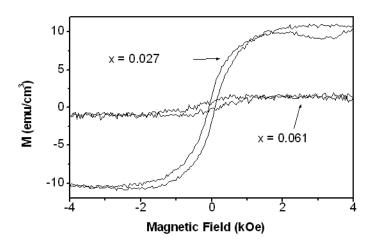


FIG. 2. – Kumar et al

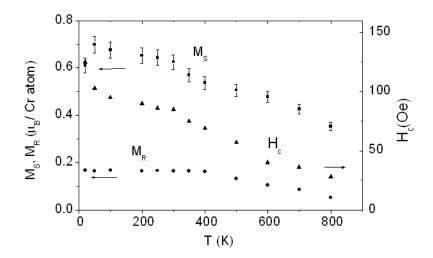


FIG. 3. – Kumar et al

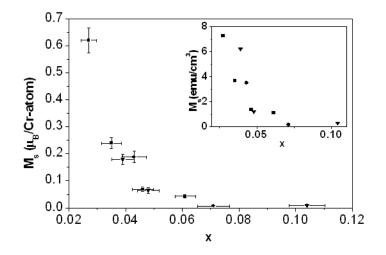


FIG. 4. – Kumar et al